

2K VESA[®] E-EDID[™] Serial EEPROM

Features

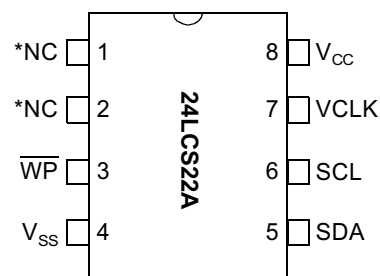
- Single supply with operation down to 2.5V
- Supports Enhanced EDID[™] (E-EDID[™]) 1.3
- Completely implements DDC1/DDC2[™] interface for monitor identification, including recovery to DDC1
- 2Kbit Serial EEPROM Low power CMOS technology:
 - 1 mA typical active current
 - 10 μ A standby current typical at 5.5V
- 2-wire serial interface bus, I²C[™] compatible
- 100 kHz (2.5V) and 400 kHz (5V) compatibility
- Self timed write cycle (including auto-erase)
- Hardware write-protect pin
- Page-write buffer for up to eight bytes
- 1,000,000 erase write cycles guaranteed
- Data retention > 200 years
- ESD protection > 4000V
- 8-pin DIP and SOIC packages
- Available temperature ranges:
 - Industrial (I) -40°C to +85°C

Description

The Microchip Technology Inc. 24LCS22A is a 256 x 8-bit dual-mode Electrically Erasable PROM (EEPROM). This device is designed for use in applications requiring storage and serial transmission of configuration and control information. Two modes of operation have been implemented: Transmit-Only Mode (1Kbit) and Bi-directional Mode (2Kbit). Upon power-up, the device will be in the Transmit-Only Mode, sending a serial bit stream of the memory array from 00h to 7Fh, clocked by the VCLK pin. A valid high to low transition on the SCL pin will cause the device to enter the transition mode, and look for a valid control byte on the I²C bus. If it detects a valid control byte from the master, it will switch into Bi-Directional Mode, with byte selectable read/write capability of the entire 2K memory array using SCL. If no control byte is received, the device will revert to the Transmit-Only Mode after it receives 128 consecutive VCLK pulses while the SCL pin is idle. The 24LCS22A is available in standard 8-pin DIP and SOIC packages. The 24LCS22A features a flexible Write-Protect pin which is enabled by writing to address 7Fh (usually the checksum in VESA[®] applications).

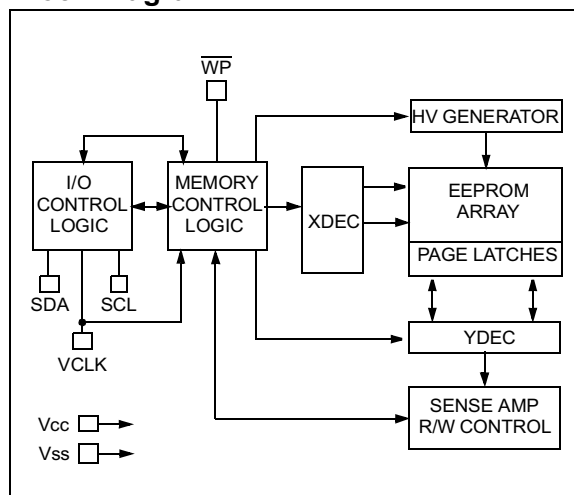
Package Types

PDIP/SOIC



* Pins labeled 'NC' have no internal connection

Block Diagram



24LCS22A

1.0 ELECTRICAL CHARACTERISTICS

Absolute Maximum Ratings†

V _{CC}	7.0V
All inputs and outputs w.r.t. V _{SS}	-0.6V to V _{CC} +1.0V
Storage temperature	-65°C to +150°C
Ambient temp. with power applied	-65°C to +125°C
Soldering temperature of leads (10 seconds)	+240°C
ESD protection on all pins	≥ 4 kV

†**Notice:** Stresses above those listed under “Maximum ratings” may cause permanent damage to the device. This is a stress rating only and functional operation of the device at those or any other conditions above those indicated in the operational listings of this specification is not implied. Exposure to maximum rating conditions for extended periods may affect device reliability.

1.1 DC Characteristics

DS Characteristics			V _{CC} = +2.5V to 5.5V Industrial (I): T _{AMB} = -40°C to +85°C			
Param. No.	Sym	Characteristic	Min.	Max.	Units	Test Conditions
SCL and SDA pins:						
D1	V _{IH}	High level input voltage	0.7 V _{CC}	—	V	
D2	V _{IL}	Low level input voltage	—	0.3 V _{CC}	V	
Input levels on VCLK pin:						
D3	V _{IH}	High level input voltage	2.0	—	V	V _{CC} ≥ 2.7V (Note)
D4	V _{IL}	Low level input voltage	—	0.2 V _{CC}	V	V _{CC} ≤ 2.7V (Note)
D5	V _{HYS}	Hysteresis of Schmitt trigger Inputs	.05 V _{CC}	—	V	(Note)
D6	V _{OL1}	Low level output voltage	—	0.4	V	I _{OL} = 3 mA, V _{CC} = 2.5V (Note)
D7	V _{OL2}	Low level output voltage	—	0.6	V	I _{OL} = 6 mA, V _{CC} = 2.5V
D8	I _{LI}	Input leakage current	-10	10	μA	V _{IN} = 0.1V to V _{CC}
D9	I _{LO}	Output leakage current	-10	10	μA	V _{OUT} = 0.1V to V _{CC}
D10	C _{IN} , C _{OUT}	Pin capacitance (all inputs/outputs)	—	10	pF	V _{CC} = 5.0V (Note) T _{AMB} = 25°C, F _{CLK} = 1 MHz
Operating current:						
D10	I _{CC WRITE}	Operating current	—	3	mA	V _{CC} = 5.5V,
D11	I _{CC READ}	Operating current	—	1	mA	V _{CC} = 5.5V, SCL = 400 kHz
D12	I _{CCS}	Standby current	—	30	μA	V _{CC} = 3.0V, SDA = SCL = V _{CC}
			—	100	μA	V _{CC} = 5.5V, SDA = SCL = V _{CC} V _{CLK} = V _{SS}

Note: This parameter is periodically sampled and not 100% tested.

1.2 AC Characteristics

AC Characteristics			V _{CC} = +2.5V to 5.5V Industrial (I): T _{AMB} = -40°C to +85°C			
Param. No.	Sym	Parameter	Min	Max	Units	Conditions
1	FCLK	Clock frequency	— —	100 400	kHz	2.5V ≤ V _{CC} ≤ 5.5V 4.5V ≤ V _{CC} ≤ 5.5V
2	THIGH	Clock high time	4000 600	— —	ns	2.5V ≤ V _{CC} ≤ 5.5V 4.5V ≤ V _{CC} ≤ 5.5V
3	TLOW	Clock low time	4700 1300	— —	ns	2.5V ≤ V _{CC} ≤ 5.5V 4.5V ≤ V _{CC} ≤ 5.5V
4	TR	SDA and SCL rise time	— —	1000 300	ns	2.5V ≤ V _{CC} ≤ 5.5V (Note 1) 4.5V ≤ V _{CC} ≤ 5.5V (Note 1)
5	TF	SDA and SCL fall time	— —	300 300	ns	(Note 1)
6	THD:STA	START condition hold time	4000 600	— —	ns	2.5V ≤ V _{CC} ≤ 5.5V 4.5V ≤ V _{CC} ≤ 5.5V
7	TSU:STA	START condition setup time	4700 600	— —	ns	2.5V ≤ V _{CC} ≤ 5.5V 4.5V ≤ V _{CC} ≤ 5.5V
8	THD:DAT	Data input hold time	0 0	— —	ns	(Note 2)
9	TSU:DAT	Data input setup time	250 100	— —	ns	2.5V ≤ V _{CC} ≤ 5.5V 4.5V ≤ V _{CC} ≤ 5.5V
10	TSU:STO	STOP condition setup time	4000 600	— —	ns	2.5V ≤ V _{CC} ≤ 5.5V 4.5V ≤ V _{CC} ≤ 5.5V
11	TAA	Output valid from clock (Note 2)	— —	3500 900	ns	2.5V ≤ V _{CC} ≤ 5.5V 4.5V ≤ V _{CC} ≤ 5.5V
12	TBUF	Bus free time: Time the bus must be free before a new transmission can start	4700 1300	— —	ns	2.5V ≤ V _{CC} ≤ 5.5V 4.5V ≤ V _{CC} ≤ 5.5V
13	TOF	Output fall time from V _{IH} minimum to V _{IL} maximum	— 20+0.1C _B	250 250	ns	2.5V ≤ V _{CC} ≤ 5.5V (Note 1) 4.5V ≤ V _{CC} ≤ 5.5V (Note 1)
14	TSP	Input filter spike suppression (SDA and SCL pins)	— —	50 50	ns	(Notes 1 and 3)
15	TWR	Write cycle time (byte or page)	— —	10 10	ms	
16	TVAA	Output valid from VCLK	— —	2000 1000	ns	
17	TVHIGH	VCLK high time	4000 600	— —	ns	
18	TVLOW	VCLK low time	4700 1300	— —	ns	
19	TVHST	VCLK setup time	0 0	— —	ns	
20	TSPVL	VCLK hold time	4000 600	— —	ns	
21	TVHZ	Mode transition time	— —	1000 500	ns	
22	TVPU	Transmit-Only power up time	0 0	— —	ns	
23	TSPV	Input filter spike suppression (VCLK pin)	— —	100 100	ns	
24	—	Endurance	1M	—	cycles	25°C, V _{CC} = 5.0V, Block Mode (Note 4)

- Note** 1: Not 100% tested. C_B = total capacitance of one bus line in pF.
- 2: As a transmitter, the device must provide an internal minimum delay time to bridge the undefined region (minimum 300 ns) of the falling edge of SCL to avoid unintended generation of START or STOP conditions.
- 3: The combined TSP and VHYS specifications are due to Schmitt trigger inputs which provide improved noise spike suppression. This eliminates the need for a TI specification for standard operation.
- 4: This parameter is not tested but established by characterization. For endurance estimates in a specific application, please consult the Total Endurance Model which can be obtained on Microchip's website.

24LCS22A

2.0 FUNCTIONAL DESCRIPTION

The 24LCS22A is designed to comply to the DDC Standard proposed by VESA (Figure 3-3) with the exception that it is not Access.bus capable. It operates in two modes, the Transmit-Only Mode (1Kbit) and the Bi-directional Mode (2Kbit). There is a separate 2-wire protocol to support each mode, each having a separate clock input but sharing a common data line (SDA). The device enters the Transmit-Only Mode upon power-up. In this mode, the device transmits data bits on the SDA pin in response to a clock signal on the VCLK pin. The device will remain in this mode until a valid high to low transition is placed on the SCL input. When a valid transition on SCL is recognized, the device will switch into the Bi-directional Mode and look for its control byte to be sent by the master. If it detects its control byte, it will stay in the Bi-directional Mode. Otherwise, it will revert to the Transmit-Only Mode after it sees 128 VCLK pulses.

2.1 Transmit-Only Mode

The device will power up in the Transmit-Only Mode at address 00H. This mode supports a unidirectional 2-wire protocol for continuous transmission of the first

1Kbit of the memory array. This device requires that it be initialized prior to valid data being sent in the Transmit-Only Mode (Section 2.2). In this mode, data is transmitted on the SDA pin in 8-bit bytes, with each byte followed by a ninth, null bit (Figure 2-1). The clock source for the Transmit-Only Mode is provided on the VCLK pin, and a data bit is output on the rising edge on this pin. The eight bits in each byte are transmitted most significant bit first. Each byte within the memory array will be output in sequence. After address 7Fh in the memory array is transmitted, the internal address pointers will wrap around to the first memory location (00h) and continue. The Bi-directional Mode Clock (SCL) pin must be held high for the device to remain in the Transmit-Only Mode.

2.2 Initialization Procedure

After VCC has stabilized, the device will be in the Transmit-Only Mode. Nine clock cycles on the VCLK pin must be given to the device for it to perform internal synchronization. During this period, the SDA pin will be in a high impedance state. On the rising edge of the tenth clock cycle, the device will output the first valid data bit which will be the most significant bit in address 00h. (Figure 2-2).

FIGURE 2-1: TRANSMIT-ONLY MODE

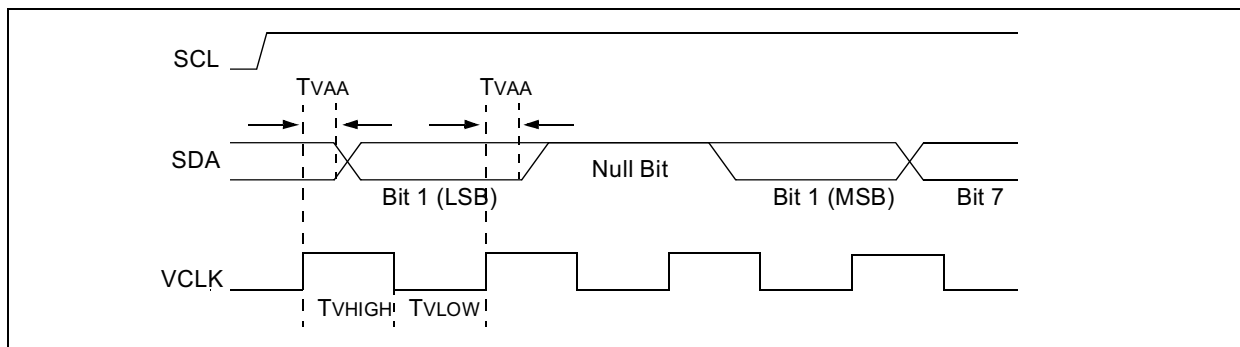
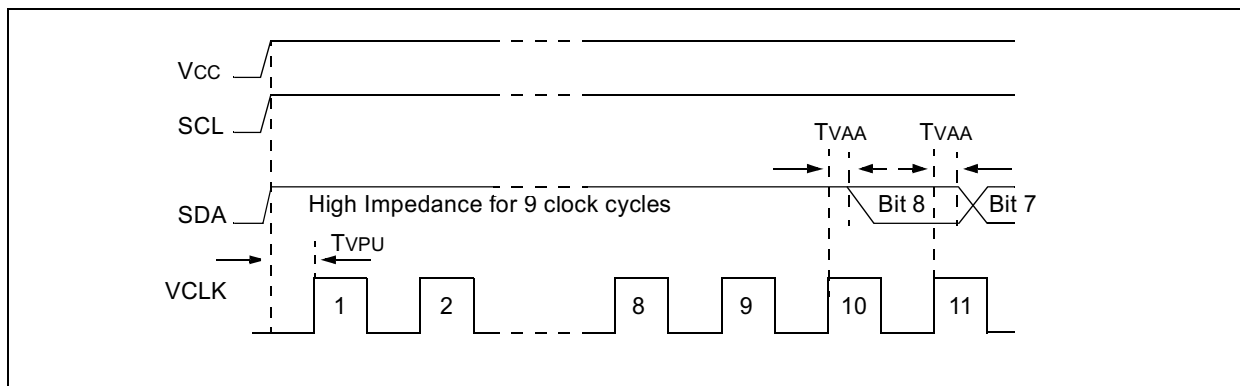


FIGURE 2-2: DEVICE INITIALIZATION



3.0 BI-DIRECTIONAL MODE

Before the 24LCS22A can be switched into the Bi-directional Mode (Figure 3-1), it must enter the transition mode, which is done by applying a valid high to low transition on the Bi-directional Mode Clock (SCL). As soon it enters the transition mode, it looks for a control byte 1010 000X on the I²C™ bus, and starts to count pulses on VCLK. Any high to low transition on the SCL line will reset the count. If it sees a pulse count of 128 on VCLK while the SCL line is idle, it will revert back to the Transmit-Only Mode, and transmit its contents starting with the most significant bit in address 00h. However, if it detects the control byte on the I²C bus, (Figure 3-2) it will switch to the Bi-directional Mode. Once the device has made the transition to the Bi-directional mode, the only way to switch the device back to the Transmit-Only Mode is to remove power from the device. The mode transition process is shown in detail in Figure 3-3.

Once the device has switched into the Bi-directional Mode, the VCLK input is disregarded, with the exception that a logic high level is required to enable write capability. In Bi-Directional mode the user has access to the entire 2K array, whereas in the Transmit-Only mode, the user can only access the first 1K. This mode supports a two-wire Bi-directional data transmission protocol (I²C™). In this protocol, a device that sends data on the bus is defined to be the transmitter, and a device that receives data from the bus is defined to be the receiver. The bus must be controlled by a master device that generates the Bi-directional Mode Clock (SCL), controls access to the bus and generates the START and STOP conditions, while the 24LCS22A acts as the slave. Both master and slave can operate as transmitter or receiver, but the master device determines which mode is activated. In the Bi-directional mode, the 24LCS22A only responds to commands for device 1010 000X.

FIGURE 3-1: MODE TRANSITION WITH RECOVERY TO TRANSMIT-ONLY MODE

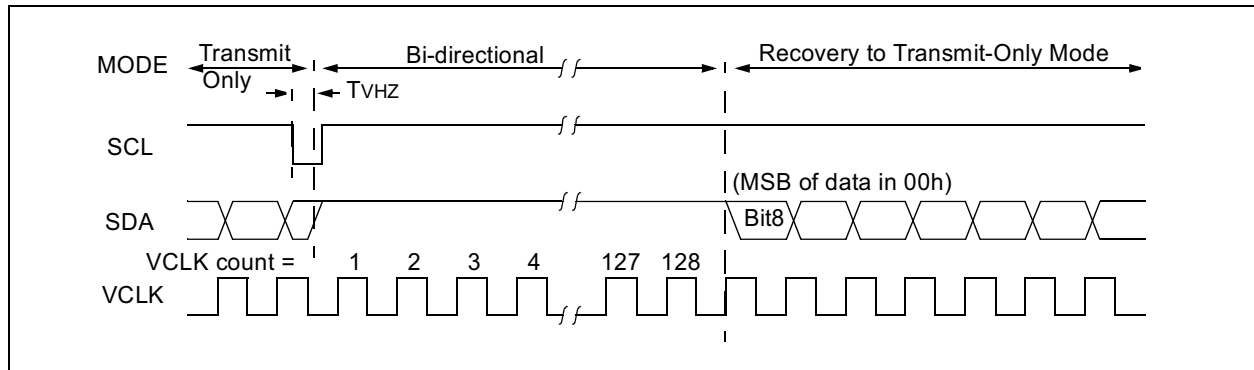


FIGURE 3-2: SUCCESSFUL MODE TRANSITION TO BI-DIRECTIONAL MODE

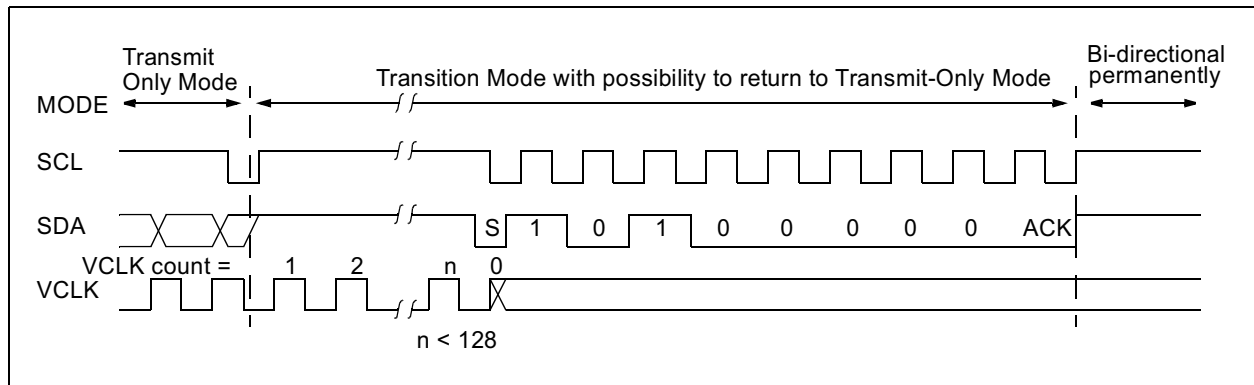
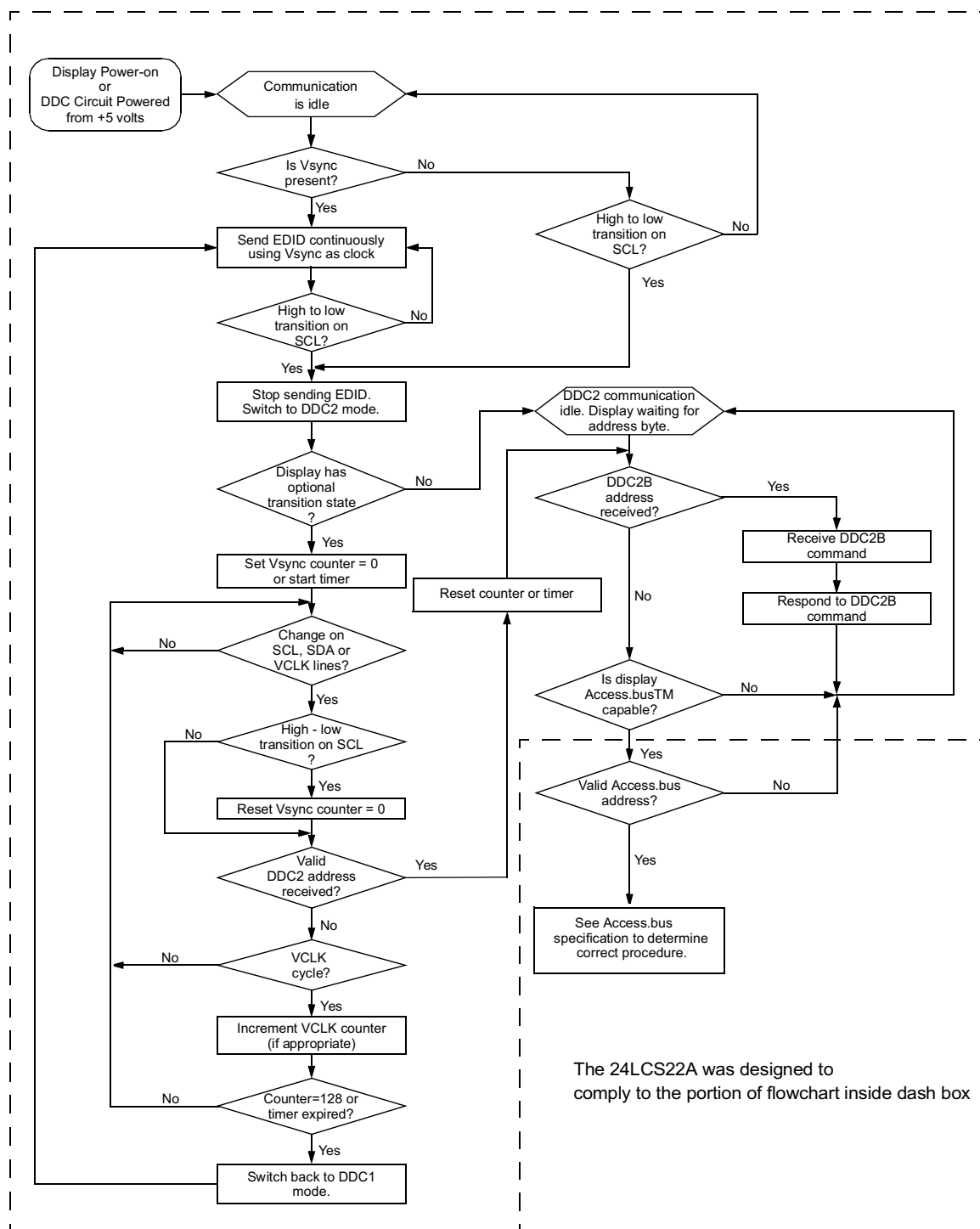


FIGURE 3-3: DISPLAY OPERATION PER DDC STANDARD PROPOSED BY VESA



The 24LCS22A was designed to comply to the portion of flowchart inside dash box

Note 1: The base flowchart is copyright © 1993, 1994, 1995 Video Electronic Standard Association (VESA) from VESA's Display Data Channel (DDC) Standard Proposal ver. 2p rev. 0, used by permission of VESA.

2: The dash box and text "The 24LCS21A and... inside dash box." are added by Microchip Technology, Inc.

3.1 Bi-directional Mode Bus Characteristics

The following **bus protocol** has been defined:

- Data transfer may be initiated only when the bus is not busy
- During data transfer, the data line must remain stable whenever the clock line is HIGH. Changes in the data line while the clock line is HIGH will be interpreted as a START or STOP condition

Accordingly, the following bus conditions have been defined (Figure 3-4).

3.1.1 BUS NOT BUSY (A)

Both data and clock lines remain HIGH.

3.1.2 START DATA TRANSFER (B)

A HIGH to LOW transition of the SDA line while the clock (SCL) is HIGH determines a START condition. All commands must be preceded by a START condition.

3.1.3 STOP DATA TRANSFER (C)

A LOW to HIGH transition of the SDA line while the clock (SCL) is HIGH determines a STOP condition. All operations must be ended with a STOP condition.

3.1.4 DATA VALID (D)

The state of the data line represents valid data when, after a START condition, the data line is stable for the duration of the HIGH period of the clock signal.

The data on the line must be changed during the LOW period of the clock signal. There is one clock pulse per bit of data.

Each data transfer is initiated with a START condition and terminated with a STOP condition. The number of the data bytes transferred between the START and STOP conditions is determined by the master device and is theoretically unlimited, although only the last eight will be stored when doing a write operation. When an overwrite does occur it will replace data in a first out fashion.

Note: Once switched into Bi-directional Mode, the 24LCS22A will remain in that mode until power is removed. Removing power is the only way to reset the 24LCS22A into the Transmit-only mode.

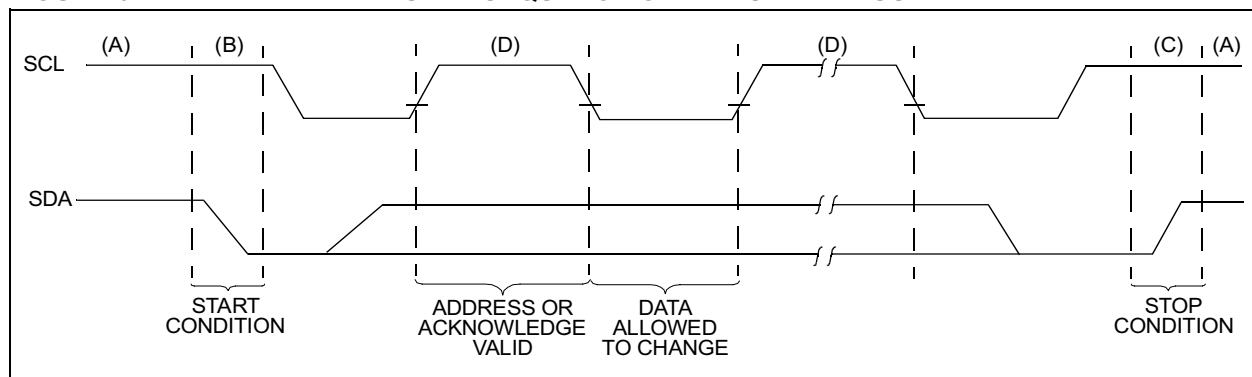
3.1.5 ACKNOWLEDGE

Each receiving device, when addressed, is obliged to generate an acknowledge after the reception of each byte. The master device must generate an extra clock pulse which is associated with this acknowledge bit.

Note: The 24LCS22A does not generate any acknowledge bits if an internal programming cycle is in progress.

The device that acknowledges has to pull down the SDA line during the acknowledge clock pulse in such a way that the SDA line is stable LOW during the HIGH period of the acknowledge related clock pulse. Of course, setup and hold times must be taken into account. A master must signal an end of data to the slave by not generating an acknowledge bit on the last byte that has been clocked out of the slave. In this case, the slave must leave the data line HIGH to enable the master to generate the STOP condition.

FIGURE 3-4: DATA TRANSFER SEQUENCE ON THE SERIAL BUS



24LCS22A

FIGURE 3-5: BUS TIMING START/STOP

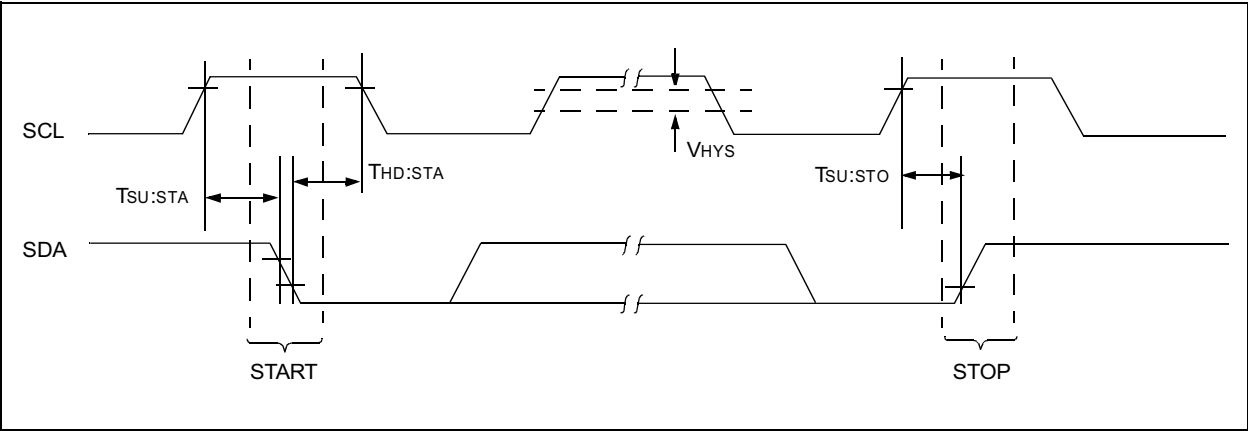
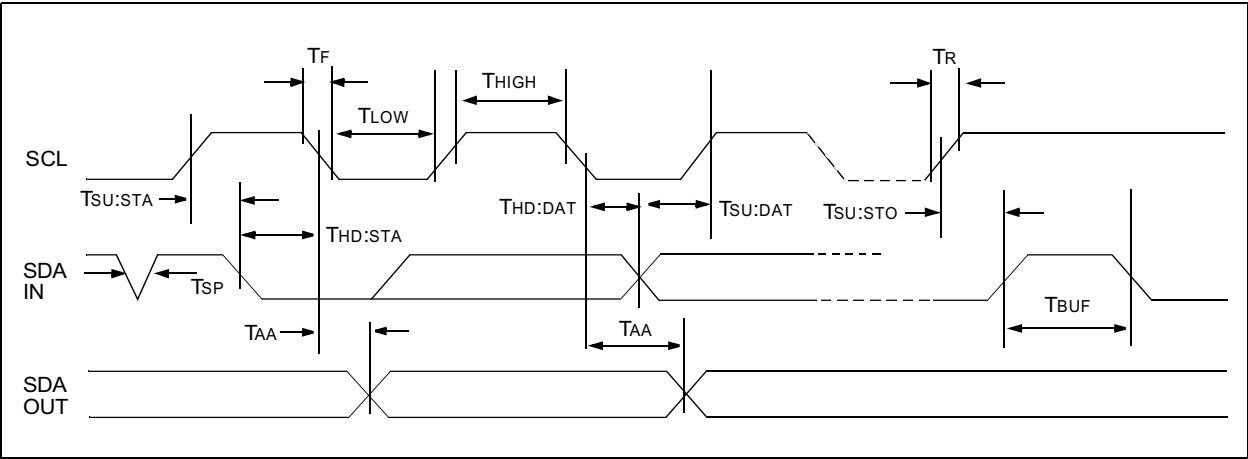


FIGURE 3-6: BUS TIMING DATA



3.1.6 SLAVE ADDRESS

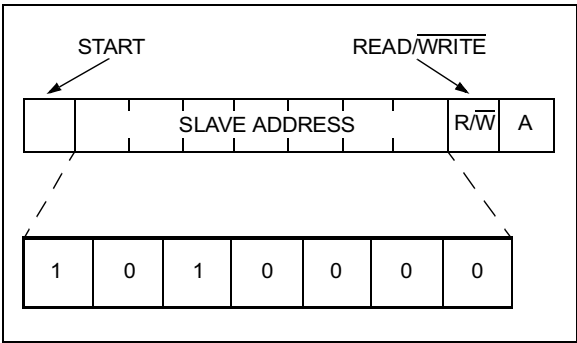
After generating a START condition, the bus master transmits the slave address consisting of a 7-bit device code (1010000) for the 24LCS22A.

The eighth bit of slave address determines whether the master device wants to read or write to the 24LCS22A (Figure 3-7).

The 24LCS22A monitors the bus for its corresponding slave address continuously. It generates an acknowledge bit if the slave address was true and it is not in a programming mode.

Operation	Slave Address	R/ \overline{W}
Read	1010000	1
Write	1010000	0

FIGURE 3-7: CONTROL BYTE ALLOCATION



4.0 WRITE OPERATION

4.1 Byte Write

Following the start signal from the master, the slave address (four bits), three zero bits (000) and the R/W bit which is a logic low are placed onto the bus by the master transmitter. This indicates to the addressed slave receiver that a byte with a word address will follow after it has generated an acknowledge bit during the ninth clock cycle. Therefore, the next byte transmitted by the master is the word address and will be written into the address pointer of the 24LCS22A. After receiving another acknowledge signal from the 24LCS22A the master device will transmit the data word to be written into the addressed memory location. The 24LCS22A acknowledges again and the master generates a stop condition. This initiates the internal write cycle, and during this time the 24LCS22A will not generate acknowledge signals (Figure 4-1).

It is required that VCLK be held at a logic high level during command and data transfer in order to program the device. This applies to both byte write and page write operation. Note, however, that the VCLK is ignored during the self-timed program operation. Changing VCLK from high to low during the self-timed program operation will not halt programming of the device.

4.2 Page Write

The write control byte, word address and the first data byte are transmitted to the 24LCS22A in the same way as in a byte write. But instead of generating a stop condition the master transmits up to eight data bytes to the 24LCS22A which are temporarily stored in the on-chip page buffer and will be written into the memory after the master has transmitted a stop condition. After the receipt of each word, the three lower order address pointer bits are internally incremented by one. The higher order five bits of the word address remains constant. If the master should transmit more than eight words prior to generating the stop condition, the address counter will roll over and the previously received data will be overwritten. As with the byte write operation, once the stop condition is received an internal write cycle will begin (Figure 5-2).

It is required that VCLK be held at a logic high level during command and data transfer in order to program the device. This applies to both byte write and page write operation. Note, however, that the VCLK is ignored during the self-timed program operation. Changing VCLK from high to low during the self-timed program operation will not halt programming of the device.

Note: Page write operations are limited to writing bytes within a single physical page, regardless of the number of bytes actually being written. Physical page boundaries start at addresses that are integer multiples of the page buffer size (or 'page size') and end at addresses that are integer multiples of [page size - 1]. If a page write command attempts to write across a physical page boundary, the result is that the data wraps around to the beginning of the current page (overwriting data previously stored there), instead of being written to the next page as might be expected. It is therefore necessary for the application software to prevent page write operations that would attempt to cross a page boundary.

24LCS22A

FIGURE 4-1: BYTE WRITE

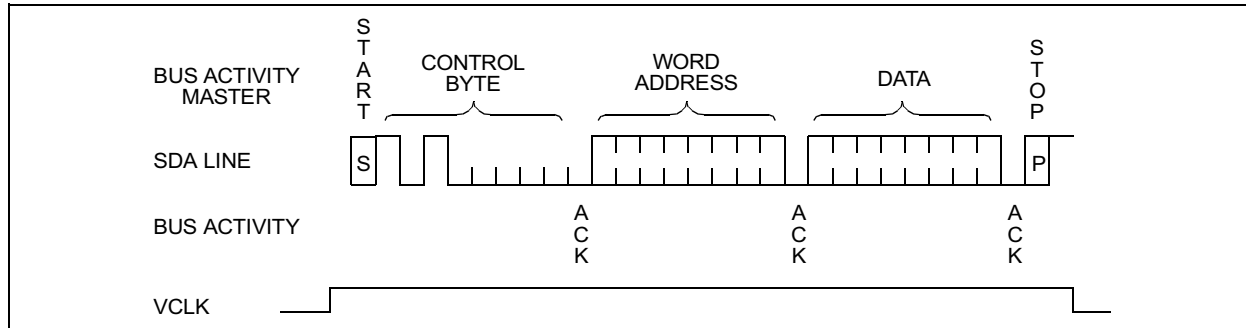
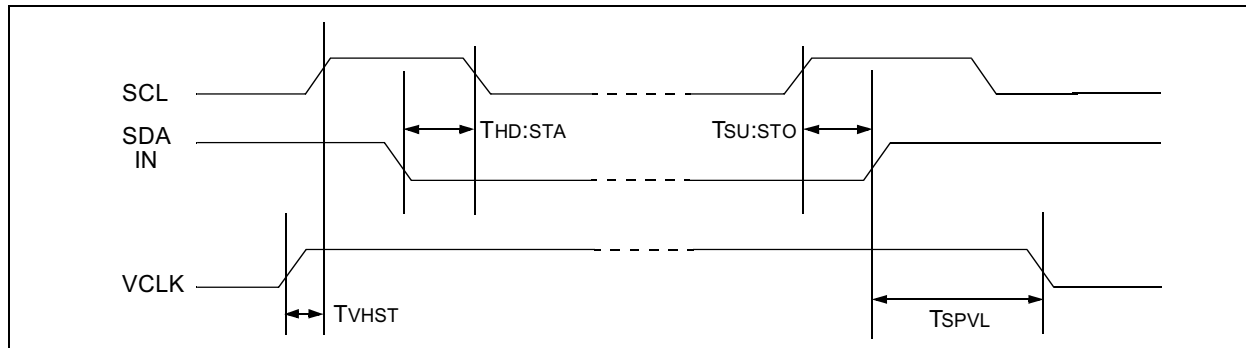


FIGURE 4-2: VCLK WRITE ENABLE TIMING



5.0 ACKNOWLEDGE POLLING

Since the device will not acknowledge during a write cycle, this can be used to determine when the cycle is complete (this feature can be used to maximize bus throughput). Once the stop condition for a write command has been issued from the master, the device initiates the internally timed write cycle. ACK polling can be initiated immediately. This involves the master sending a start condition followed by the control byte for a write command ($R/W = 0$). If the device is still busy with the write cycle, then no ACK will be returned. If the cycle is complete, then the device will return the ACK and the master can then proceed with the next read or write command. See Figure 5-1 for the flow diagram.

FIGURE 5-1: ACKNOWLEDGE POLLING FLOW

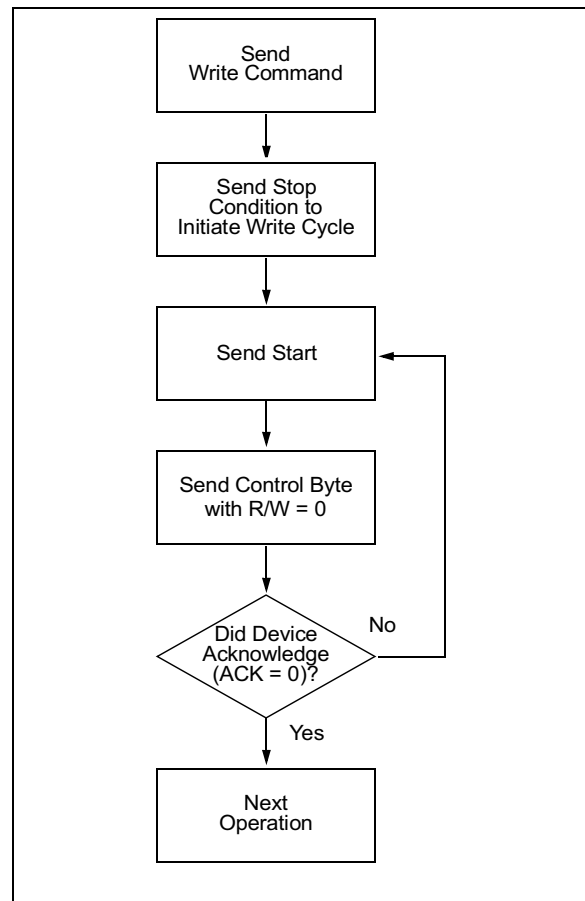
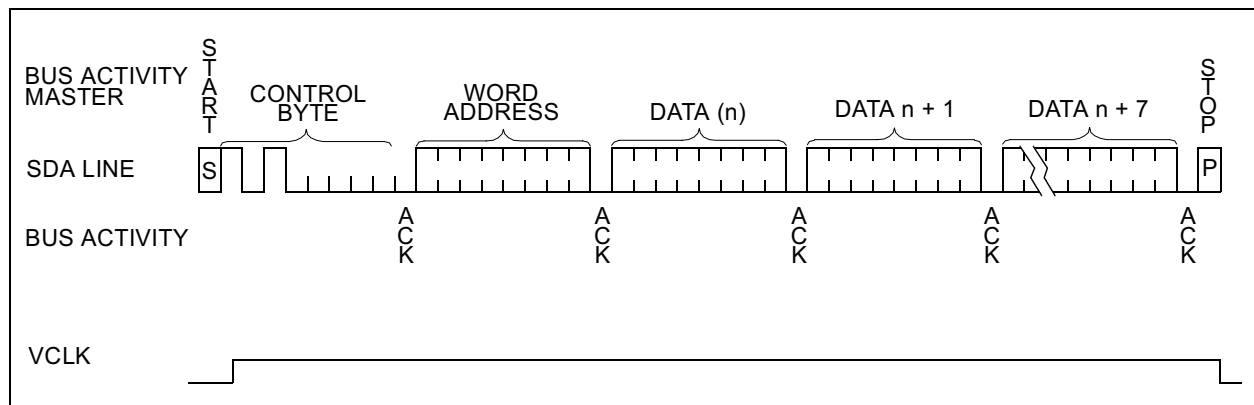


FIGURE 5-2: PAGE WRITE



24LCS22A

6.0 WRITE PROTECTION

When using the 24LCS22A in the Bi-directional Mode, the VCLK pin can be used as a write protect control pin. Setting VCLK high allows normal write operations, while setting VCLK low prevents writing to any location in the array. Connecting the VCLK pin to Vss would allow the 24LCS22A to operate as a serial ROM, although this configuration would prevent using the device in the Transmit-Only Mode.

Additionally, Pin three performs a flexible write protect function. The 24LCS22A contains a write-protection control fuse whose factory default state is cleared. Writing any data to address 7Fh (normally the checksum in DDC applications) sets the fuse which enables the $\overline{\text{WP}}$ pin. Until this fuse is set, the 24LCS22A is always write enabled (if VCLK = 1). After the fuse is set, the write capability of the 24LCS22A is determined by both VCLK and WP pins (Table 6-1).

TABLE 6-1: WRITE PROTECT TRUTH TABLE

VCLK	$\overline{\text{WP}}$	Address 7Fh Written	Mode for 00h - 7Fh
0	X	X	Read Only
1	X	No	R/ $\overline{\text{W}}$
1	1/open	X	R/ $\overline{\text{W}}$
1	0	Yes	Read Only

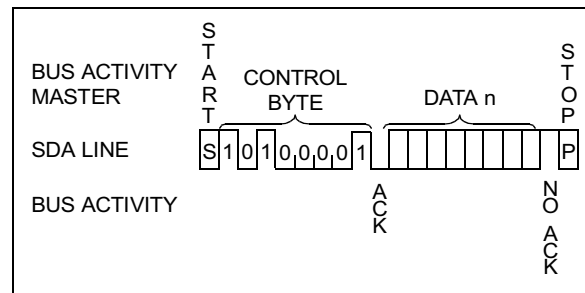
7.0 READ OPERATION

Read operations are initiated in the same way as write operations with the exception that the R/W bit of the slave address is set to one. There are three basic types of read operations: current address read, random read and sequential read.

7.1 Current Address Read

The 24LCS22A contains an address counter that maintains the address of the last word accessed, internally incremented by one. Therefore, if the previous access (either a read or write operation) was to address n, the next current address read operation would access data from address n + 1. Upon receipt of the slave address with R/W bit set to one, the 24LCS22A issues an acknowledge and transmits the eight bit data word. The master will not acknowledge the transfer but does generate a stop condition and the 24LCS22A discontinues transmission (Figure 7-1).

FIGURE 7-1: CURRENT ADDRESS READ



7.2 Random Read

Random read operations allow the master to access any memory location in a random manner. To perform this type of read operation, first the word address must be set. This is done by sending the word address to the 24LCS22A as part of a write operation. After the word address is sent, the master generates a start condition following the acknowledge. This terminates the write operation, but not before the internal address pointer is set. Then the master issues the control byte again but with the R/W bit set to a one. The 24LCS22A will then issue an acknowledge and transmits the 8-bit data word. The master will not acknowledge the transfer but does generate a stop condition and the 24LCS22A discontinues transmission (Figure 7-2).

FIGURE 7-2: RANDOM READ

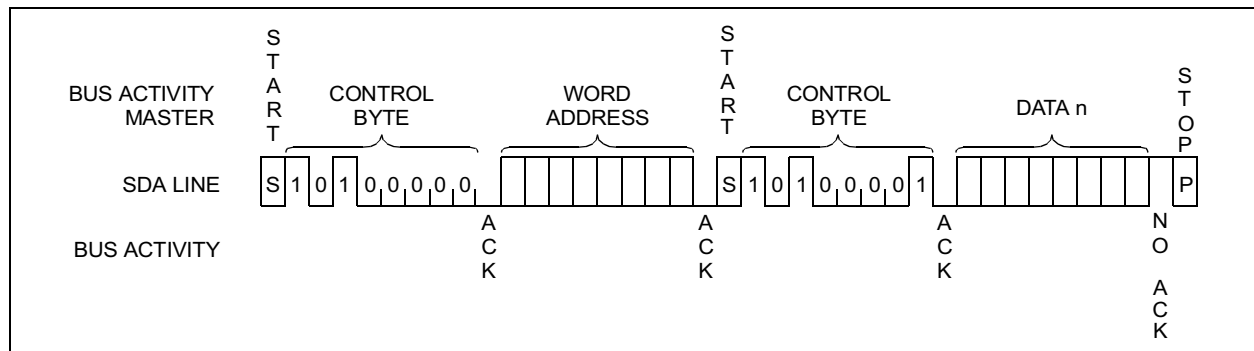
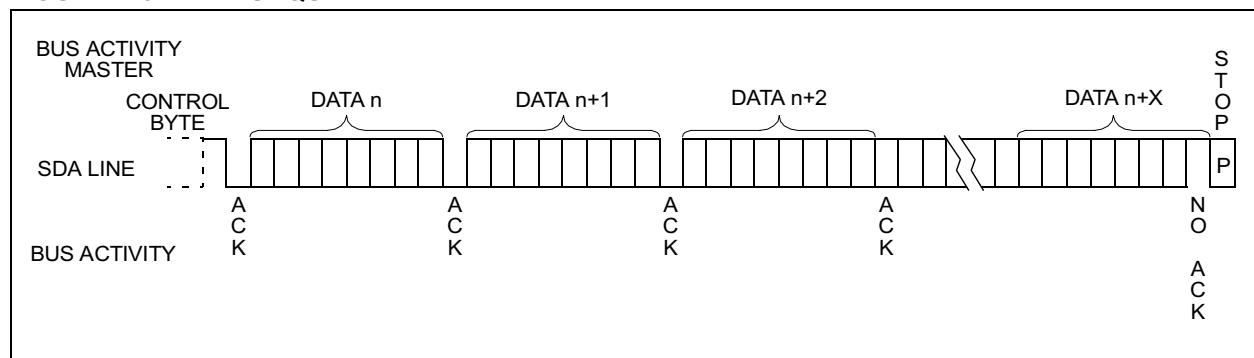


FIGURE 7-3: SEQUENTIAL READ



7.3 Sequential Read

Sequential reads are initiated in the same way as a random read except that after the 24LCS22A transmits the first data byte, the master issues an acknowledge as opposed to a stop condition in a random read. This directs the 24LCS22A to transmit the next sequentially addressed 8-bit word (Figure 7-3).

To provide sequential reads the 24LCS22A contains an internal address pointer which is incremented by one at the completion of each operation. This address pointer allows the entire memory contents to be serially read during one operation.

7.4 Noise Protection

The 24LCS22A employs a VCC threshold detector circuit which disables the internal erase/write logic if the VCC is below 1.5 volts at nominal conditions.

The SDA, SCL and VCLK inputs have Schmitt trigger and filter circuits which suppress noise spikes to assure proper device operation even on a noisy bus.

8.0 PIN DESCRIPTIONS

The descriptions of the pins are listed in Table 8-1.

TABLE 8-1: PIN FUNCTION TABLE

Name	Function
$\overline{\text{WP}}$	Write Protect (active low)
VSS	Ground
SDA	Serial Address/Data I/O
SCL	Serial Clock (Bi-directional Mode)
VCLK	Serial Clock (Transmit-Only Mode)
VCC	+2.5V to 5.5V Power Supply
NC	No Internal Connection

8.1 Write Protect ($\overline{\text{WP}}$)

This pin is used for flexible write protection of the 24LCS22A. When memory location 7Fh is written with any data, this pin is enabled and determines the write capability of the 24LCS22A (Table 6-1).

The $\overline{\text{WP}}$ pin has an internal pull up resistor which will allow write capability (assuming VCLK = 1) at all times if this pin is floated.

8.2 Serial Address/Data Input/Output (SDA)

This pin is used to transfer addresses and data into and out of the device, when the device is in the Bi-directional Mode. In the Transmit-Only Mode, which only allows data to be read from the device, data is also transferred on the SDA pin. This pin is an open drain terminal, therefore the SDA bus requires a pullup resistor to VCC (typical 10 k Ω for 100 kHz, 1 k Ω for 400 kHz).

For normal data transfer in the Bi-directional Mode, SDA is allowed to change only during SCL low. Changes during SCL high are reserved for indicating the START and STOP conditions.

8.3 Serial Clock (SCL)

This pin is the clock input for the Bi-directional Mode, and is used to synchronize data transfer to and from the device. It is also used as the signaling input to switch the device from the Transmit-Only Mode to the Bi-directional Mode. It must remain high for the chip to continue operation in the Transmit-Only Mode.

8.4 Serial Clock (VCLK)

This pin is the clock input for the Transmit-Only Mode (DDC1). In the Transmit-Only Mode, each bit is clocked out on the rising edge of this signal. In the Bi-directional Mode, a high logic level is required on this pin to enable write capability.

24LCS22A

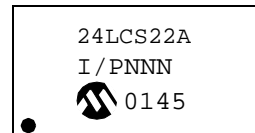
9.0 PACKAGING INFORMATION

9.1 Package Marking Information

8-Lead PDIP (300 mil)



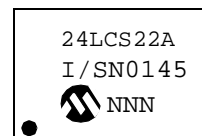
Example:



8-Lead SOIC (150 mil)



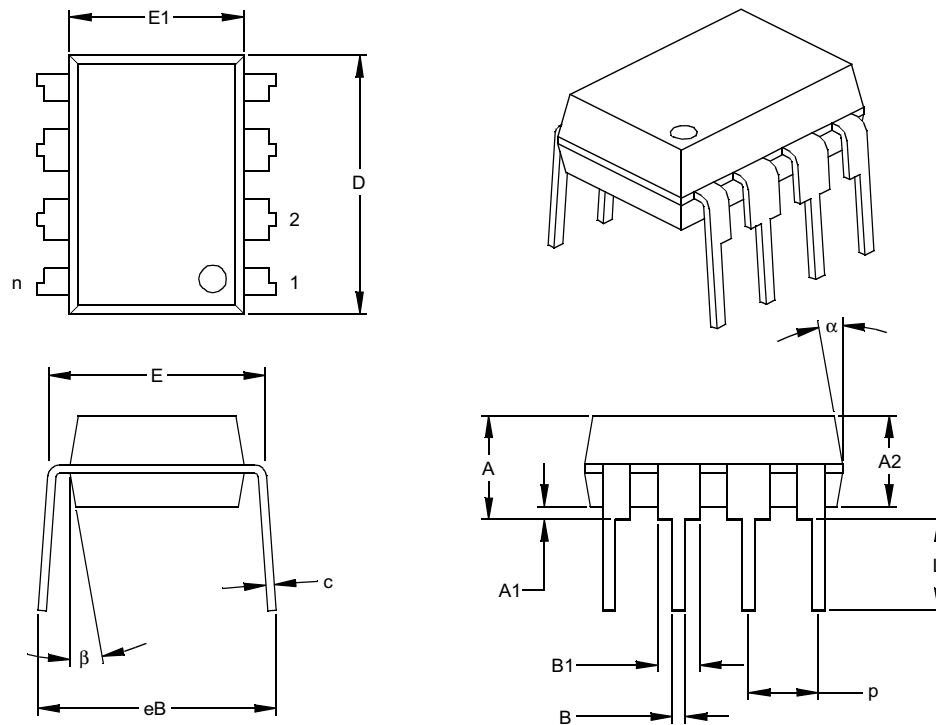
Example:



Legend:	XX...X	Customer specific information*
	YY	Year code (last 2 digits of calendar year)
	WW	Week code (week of January 1 is week '01')
	NNN	Alphanumeric traceability code
Note:	In the event the full Microchip part number cannot be marked on one line, it will be carried over to the next line thus limiting the number of available characters for customer specific information.	

- * Standard marking consists of Microchip part number, year code, week code, traceability code (facility code, mask rev#, and assembly code).

8-Lead Plastic Dual In-line (P) – 300 mil (PDIP)



Units		INCHES*			MILLIMETERS		
Dimension Limits		MIN	NOM	MAX	MIN	NOM	MAX
Number of Pins	n		8			8	
Pitch	p		.100			2.54	
Top to Seating Plane	A	.140	.155	.170	3.56	3.94	4.32
Molded Package Thickness	A2	.115	.130	.145	2.92	3.30	3.68
Base to Seating Plane	A1	.015			0.38		
Shoulder to Shoulder Width	E	.300	.313	.325	7.62	7.94	8.26
Molded Package Width	E1	.240	.250	.260	6.10	6.35	6.60
Overall Length	D	.360	.373	.385	9.14	9.46	9.78
Tip to Seating Plane	L	.125	.130	.135	3.18	3.30	3.43
Lead Thickness	c	.008	.012	.015	0.20	0.29	0.38
Upper Lead Width	B1	.045	.058	.070	1.14	1.46	1.78
Lower Lead Width	B	.014	.018	.022	0.36	0.46	0.56
Overall Row Spacing	§ eB	.310	.370	.430	7.87	9.40	10.92
Mold Draft Angle Top	α	5	10	15	5	10	15
Mold Draft Angle Bottom	β	5	10	15	5	10	15

* Controlling Parameter

§ Significant Characteristic

Notes:

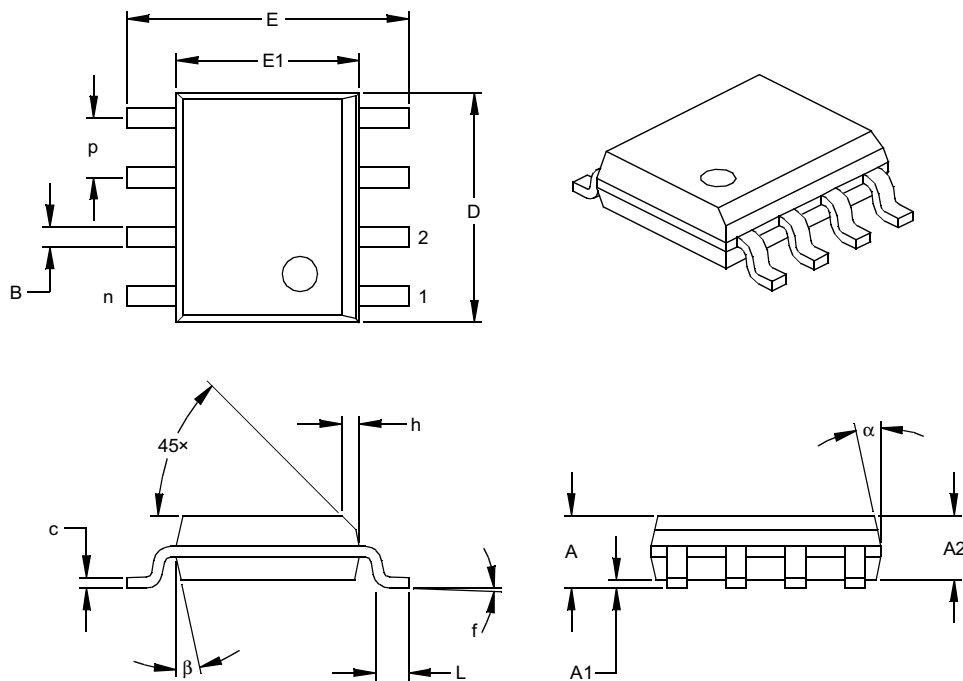
Dimensions D and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed .010" (0.254mm) per side.

JEDEC Equivalent: MS-001

Drawing No. C04-018

24LCS22A

8-Lead Plastic Small Outline (SN) – Narrow, 150 mil (SOIC)



Units		INCHES*			MILLIMETERS		
Dimension Limits		MIN	NOM	MAX	MIN	NOM	MAX
Number of Pins	n		8			8	
Pitch	p		.050			1.27	
Overall Height	A	.053	.061	.069	1.35	1.55	1.75
Molded Package Thickness	A2	.052	.056	.061	1.32	1.42	1.55
Standoff §	A1	.004	.007	.010	0.10	0.18	0.25
Overall Width	E	.228	.237	.244	5.79	6.02	6.20
Molded Package Width	E1	.146	.154	.157	3.71	3.91	3.99
Overall Length	D	.189	.193	.197	4.80	4.90	5.00
Chamfer Distance	h	.010	.015	.020	0.25	0.38	0.51
Foot Length	L	.019	.025	.030	0.48	0.62	0.76
Foot Angle	f	0	4	8	0	4	8
Lead Thickness	c	.008	.009	.010	0.20	0.23	0.25
Lead Width	B	.013	.017	.020	0.33	0.42	0.51
Mold Draft Angle Top	α	0	12	15	0	12	15
Mold Draft Angle Bottom	β	0	12	15	0	12	15

* Controlling Parameter

§ Significant Characteristic

Notes:

Dimensions D and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed .010" (0.254mm) per side.

JEDEC Equivalent: MS-012

Drawing No. C04-057

ON-LINE SUPPORT

Microchip provides on-line support on the Microchip World Wide Web (WWW) site.

The web site is used by Microchip as a means to make files and information easily available to customers. To view the site, the user must have access to the Internet and a web browser, such as Netscape or Microsoft Explorer. Files are also available for FTP download from our FTP site.

Connecting to the Microchip Internet Web Site

The Microchip web site is available by using your favorite Internet browser to attach to:

www.microchip.com

The file transfer site is available by using an FTP service to connect to:

<ftp://ftp.microchip.com>

The web site and file transfer site provide a variety of services. Users may download files for the latest Development Tools, Data Sheets, Application Notes, User's Guides, Articles and Sample Programs. A variety of Microchip specific business information is also available, including listings of Microchip sales offices, distributors and factory representatives. Other data available for consideration is:

- Latest Microchip Press Releases
- Technical Support Section with Frequently Asked Questions
- Design Tips
- Device Errata
- Job Postings
- Microchip Consultant Program Member Listing
- Links to other useful web sites related to Microchip Products
- Conferences for products, Development Systems, technical information and more
- Listing of seminars and events

Systems Information and Upgrade Hot Line

The Systems Information and Upgrade Line provides system users a listing of the latest versions of all of Microchip's development systems software products. Plus, this line provides information on how customers can receive any currently available upgrade kits. The Hot Line Numbers are:

1-800-755-2345 for U.S. and most of Canada, and

1-480-792-7302 for the rest of the world.

013001

PRODUCT IDENTIFICATION SYSTEM

To order or obtain information, e.g., on pricing or delivery, refer to the factory or the listed sales office.

<u>PART NO.</u>	<u>X</u>	<u>/XX</u>
Device	Temperature Range	Package
Device:	24LCS22A: 2K VESA E-EDID Serial EEPROM 24LCS22AT: 2K VESA E-EDID Serial EEPROM (Tape and Reel)	
Temperature Range:	I = -40°C to +85°C	
Package:	P = Plastic DIP (300 mil Body), 8-Lead SN = Plastic SOIC (150 mil Body), 8-Lead	

Examples:

- a) 24LCS22A-I/P: Industrial temperature, PDIP package.
- b) 24LCS22A-I/SN: Industrial temperature, SOIC package.
- c) 24LCS22AT-I/SN: Tape and Reel, Industrial temperature, SOIC package.

Sales and Support

Data Sheets

Products supported by a preliminary Data Sheet may have an errata sheet describing minor operational differences and recommended workarounds. To determine if an errata sheet exists for a particular device, please contact one of the following:

1. Your local Microchip sales office
2. The Microchip Corporate Literature Center U.S. FAX: (480) 792-7277
3. The Microchip Worldwide Site (www.microchip.com)

Please specify which device, revision of silicon and Data Sheet (include Literature #) you are using.

New Customer Notification System

Register on our web site (www.microchip.com/cn) to receive the most current information on our products.

24LCS22A

NOTES:

Information contained in this publication regarding device applications and the like is intended through suggestion only and may be superseded by updates. It is your responsibility to ensure that your application meets with your specifications. No representation or warranty is given and no liability is assumed by Microchip Technology Incorporated with respect to the accuracy or use of such information, or infringement of patents or other intellectual property rights arising from such use or otherwise. Use of Microchip's products as critical components in life support systems is not authorized except with express written approval by Microchip. No licenses are conveyed, implicitly or otherwise, under any intellectual property rights.

Trademarks


The Microchip name and logo, the Microchip logo, FilterLab, KEELOQ, MPLAB, PIC, PICmicro, PICMASTER, PICSTART, PRO MATE, SEEVAL and The Embedded Control Solutions Company are registered trademarks of Microchip Technology Incorporated in the U.S.A. and other countries.

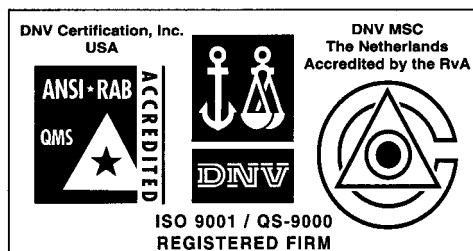
dsPIC, ECONOMONITOR, FanSense, FlexROM, fuzzyLAB, In-Circuit Serial Programming, ICSP, ICEPIC, microID, microPort, Migratable Memory, MPASM, MPLIB, MPLINK, MPSIM, MXDEV, PICC, PICDEM, PICDEM.net, rPIC, Select Mode and Total Endurance are trademarks of Microchip Technology Incorporated in the U.S.A.

Serialized Quick Term Programming (SQTP) is a service mark of Microchip Technology Incorporated in the U.S.A.

All other trademarks mentioned herein are property of their respective companies.

© 2001, Microchip Technology Incorporated, Printed in the U.S.A., All Rights Reserved.

 Printed on recycled paper.



Microchip received QS-9000 quality system certification for its worldwide headquarters, design and wafer fabrication facilities in Chandler and Tempe, Arizona in July 1999. The Company's quality system processes and procedures are QS-9000 compliant for its PICmicro® 8-bit MCUs, KEELOQ® code hopping devices, Serial EEPROMs and microperipheral products. In addition, Microchip's quality system for the design and manufacture of development systems is ISO 9001 certified.



WORLDWIDE SALES AND SERVICE

AMERICAS

Corporate Office

2355 West Chandler Blvd.
Chandler, AZ 85224-6199
Tel: 480-792-7200 Fax: 480-792-7277
Technical Support: 480-792-7627
Web Address: <http://www.microchip.com>

Rocky Mountain

2355 West Chandler Blvd.
Chandler, AZ 85224-6199
Tel: 480-792-7966 Fax: 480-792-7456

Atlanta

500 Sugar Mill Road, Suite 200B
Atlanta, GA 30350
Tel: 770-640-0034 Fax: 770-640-0307

Boston

2 Lan Drive, Suite 120
Westford, MA 01886
Tel: 978-692-3848 Fax: 978-692-3821

Chicago

333 Pierce Road, Suite 180
Itasca, IL 60143
Tel: 630-285-0071 Fax: 630-285-0075

Dallas

4570 Westgrove Drive, Suite 160
Addison, TX 75001
Tel: 972-818-7423 Fax: 972-818-2924

Dayton

Two Prestige Place, Suite 130
Miamisburg, OH 45342
Tel: 937-291-1654 Fax: 937-291-9175

Detroit

Tri-Atria Office Building
32255 Northwestern Highway, Suite 190
Farmington Hills, MI 48334
Tel: 248-538-2250 Fax: 248-538-2260

Kokomo

2767 S. Albright Road
Kokomo, Indiana 46902
Tel: 765-864-8360 Fax: 765-864-8387

Los Angeles

18201 Von Karman, Suite 1090
Irvine, CA 92612
Tel: 949-263-1888 Fax: 949-263-1338

New York

150 Motor Parkway, Suite 202
Hauppauge, NY 11788
Tel: 631-273-5305 Fax: 631-273-5335

San Jose

Microchip Technology Inc.
2107 North First Street, Suite 590
San Jose, CA 95131
Tel: 408-436-7950 Fax: 408-436-7955

Toronto

6285 Northam Drive, Suite 108
Mississauga, Ontario L4V 1X5, Canada
Tel: 905-673-0699 Fax: 905-673-6509

ASIA/PACIFIC

Australia

Microchip Technology Australia Pty Ltd
Suite 22, 41 Rawson Street
Epping 2121, NSW
Australia
Tel: 61-2-9868-6733 Fax: 61-2-9868-6755

China - Beijing

Microchip Technology Consulting (Shanghai)
Co., Ltd., Beijing Liaison Office
Unit 915
Bei Hai Wan Tai Bldg.
No. 6 Chaoyangmen Beidajie
Beijing, 100027, No. China
Tel: 86-10-85282100 Fax: 86-10-85282104

China - Chengdu

Microchip Technology Consulting (Shanghai)
Co., Ltd., Chengdu Liaison Office
Rm. 2401, 24th Floor,
Ming Xing Financial Tower
No. 88 TIDU Street
Chengdu 610016, China
Tel: 86-28-6766200 Fax: 86-28-6766599

China - Fuzhou

Microchip Technology Consulting (Shanghai)
Co., Ltd., Fuzhou Liaison Office
Rm. 531, North Building
Fujian Foreign Trade Center Hotel
73 Wusi Road
Fuzhou 350001, China
Tel: 86-591-7557563 Fax: 86-591-7557572

China - Shanghai

Microchip Technology Consulting (Shanghai)
Co., Ltd.
Room 701, Bldg. B
Far East International Plaza
No. 317 Xian Xia Road
Shanghai, 200051
Tel: 86-21-6275-5700 Fax: 86-21-6275-5060

China - Shenzhen

Microchip Technology Consulting (Shanghai)
Co., Ltd., Shenzhen Liaison Office
Rm. 1315, 13/F, Shenzhen Kerry Centre,
Renminnan Lu
Shenzhen 518001, China
Tel: 86-755-2350361 Fax: 86-755-2366086

Hong Kong

Microchip Technology Hongkong Ltd.
Unit 901-6, Tower 2, Metroplaza
223 Hing Fong Road
Kwai Fong, N.T., Hong Kong
Tel: 852-2401-1200 Fax: 852-2401-3431

India

Microchip Technology Inc.
India Liaison Office
Divyasree Chambers
1 Floor, Wing A (A3/A4)
No. 11, O'Shaughnessy Road
Bangalore, 560 025, India
Tel: 91-80-2290061 Fax: 91-80-2290062

Japan

Microchip Technology Japan K.K.
Benex S-1 6F
3-18-20, Shinyokohama
Kohoku-Ku, Yokohama-shi
Kanagawa, 222-0033, Japan
Tel: 81-45-471-6166 Fax: 81-45-471-6122

Korea

Microchip Technology Korea
168-1, Youngbo Bldg. 3 Floor
Samsung-Dong, Kangnam-Ku
Seoul, Korea 135-882
Tel: 82-2-554-7200 Fax: 82-2-558-5934

Singapore

Microchip Technology Singapore Pte Ltd.
200 Middle Road
#07-02 Prime Centre
Singapore, 188980
Tel: 65-334-8870 Fax: 65-334-8850

Taiwan

Microchip Technology Taiwan
11F-3, No. 207
Tung Hua North Road
Taipei, 105, Taiwan
Tel: 886-2-2717-7175 Fax: 886-2-2545-0139

EUROPE

Denmark

Microchip Technology Nordic ApS
Regus Business Centre
Lautrup høj 1-3
Ballerup DK-2750 Denmark
Tel: 45 4420 9895 Fax: 45 4420 9910

France

Microchip Technology SARL
Parc d'Activite du Moulin de Massy
43 Rue du Saule Trapu
Batiment A - 1er Etage
91300 Massy, France
Tel: 33-1-69-53-63-20 Fax: 33-1-69-30-90-79

Germany

Microchip Technology GmbH
Gustav-Heinemann Ring 125
D-81739 Munich, Germany
Tel: 49-89-627-144 0 Fax: 49-89-627-144-44

Italy

Microchip Technology SRL
Centro Direzionale Colleoni
Palazzo Taurus 1 V. Le Colleoni 1
20041 Agrate Brianza
Milan, Italy
Tel: 39-039-65791-1 Fax: 39-039-6899883

United Kingdom

Arizona Microchip Technology Ltd.
505 Eskdale Road
Winnersh Triangle
Wokingham
Berkshire, England RG41 5TU
Tel: 44 118 921 5869 Fax: 44-118 921-5820

10/01/01

